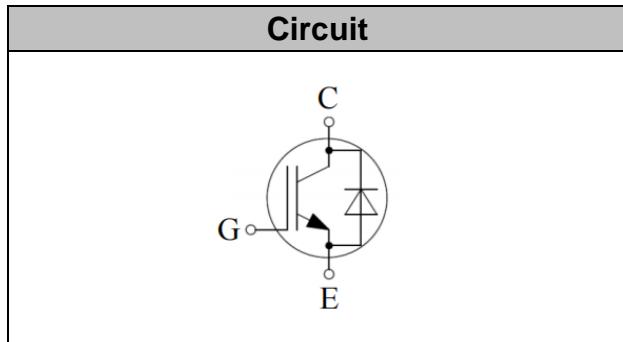


IGBT Discrete

V_{CE}	650	V
I_C	30	A
$V_{CE(SAT)} I_C=30A$	1.95	V



Applications

- High frequency switching application
- Medical applications
- Uninterruptible power supply
- Motion/servo control

Features

- Low switching losses
- Maximum junction temperature 175°C
- Positive temperature coefficient
- High ruggedness, temperature stable
- High short circuit capability(5us)

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-Emitter Breakdown Voltage	V_{CE}	650	V
DC Collector Current, limited by T_{jmax} $T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$	I_C	60 30	A
Diode Forward Current, limited by T_{jmax} $T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$	I_F	60 30	A
Continuous Gate-Emitter Voltage	V_{GE}	± 20	V
Transient Gate-Emitter Voltage ($t_p \leq 10\mu\text{s}, D < 0.010$)	V_{GE}	± 30	V
Turn off Safe Operating Area $V_{CE} \leq 650\text{V}$, $T_j \leq 150^\circ\text{C}$		120	A
Pulsed Collector Current, $V_{GE} = 15\text{V}$, t_p limited by T_{jmax}	I_{CM}	120	A
Diode Pulsed Current, t_p limited by T_{jmax}	I_{Fpuls}	120	A
Short Circuit Withstand Time, $V_{GE} = 15\text{V}$, $V_{CC} = 400\text{V}$, $V_{CEM} \leq 650\text{V}$	T_{sc}	5	μs
Power Dissipation, $T_j = 175^\circ\text{C}$, $T_c = 25^\circ\text{C}$	P_{tot}	187	W



Operating Junction Temperature	T _j	-40...+175	°C
Storage Temperature	T _s	-55...+150	°C
Soldering Temperature, wave soldering 1.6mm (0.063in.) from case for 10s		260	°C

Electrical Characteristics of the IGBT (T_j= 25°C unless otherwise specified):

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Static						
Collector-Emitter Breakdown Voltage	BV _{CES}	V _{GE} =0V, I _C =250μA	650		-	V
Gate Threshold Voltage	V _{GE(th)}	V _{GE} =V _{CE} , I _C =0.43mA	4.1	5.1	6.1	V
Collector-Emitter Saturation Voltage	V _{CE(sat)}	V _{GE} =15V, I _C =30A T _j =25°C T _j =125°C T _j =150°C		1.95 2.30 2.40	2.40	V
Zero Gate Voltage Collector Current	I _{CES}	V _{CE} =650V, V _{GE} =0V T _j = 25°C, T _j =150°C			0.25 4.00	mA
Gate-Emitter Leakage Current	I _{GES}	V _{CE} = 0V, V _{GE} = ± 20V			100	nA

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Dynamic						
Input Capacitance	C _{ies}	V _{CE} = 25V, V _{GE} = 0V,	-	1.16	-	
Reverse Transfer Capacitance	C _{res}	f = 1MHz	-	0.05	-	nF
Gate Charge	Q _G	V _{CC} =300V, I _C =30A, V _{GE} =15V	-	0.15	-	uC
Short Circuit Collector Current	I _{SC}	V _{GE} =15V, t _{sc} ≤5us, V _{CC} =300V, T _j ≤150°C	-	150	-	A

**Electrical Characteristics of the Diode (T_j= 25°C unless otherwise specified):**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Static						
Diode Forward Voltage	V _F	I _F = 30A T _j = 25°C, T _j = 125°C T _j = 150°C		1.90 1.85 1.75	2.60	V

Switching Characteristic, Inductive Load

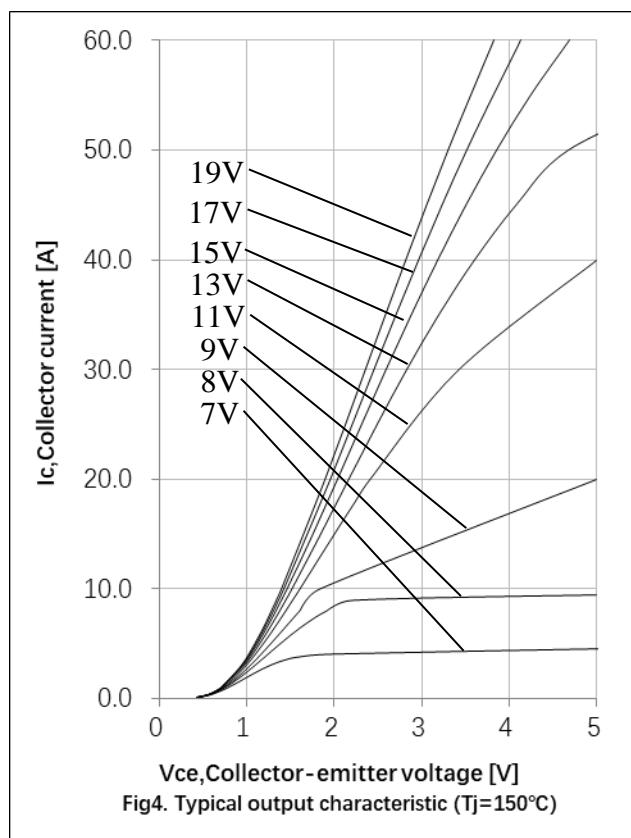
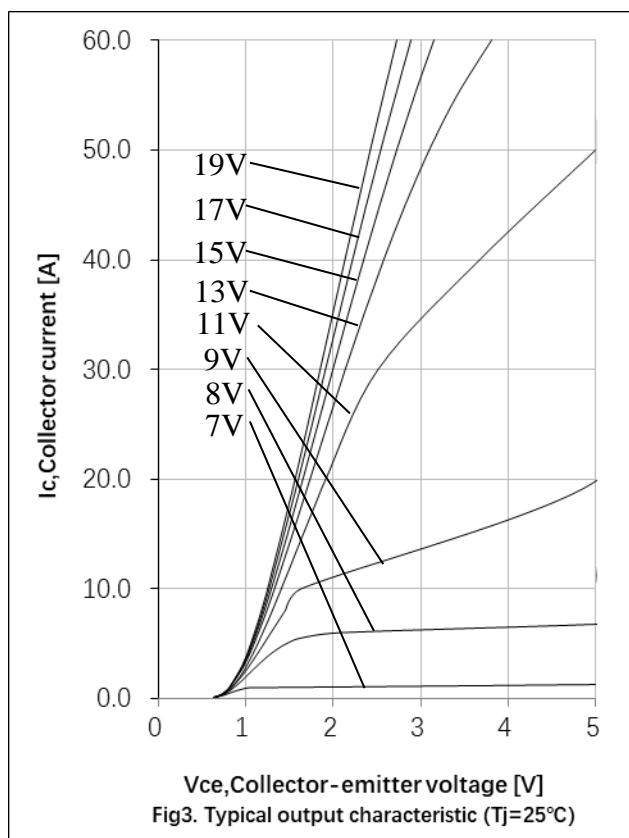
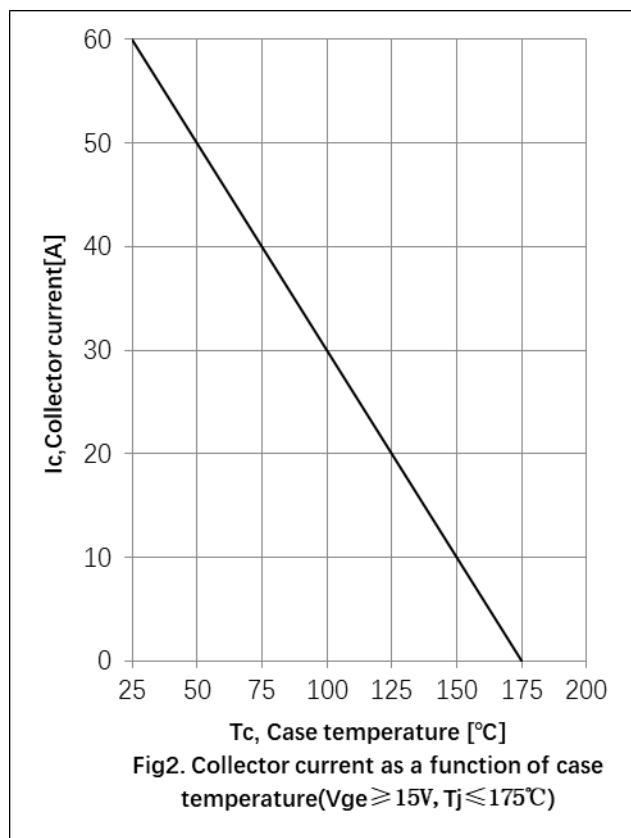
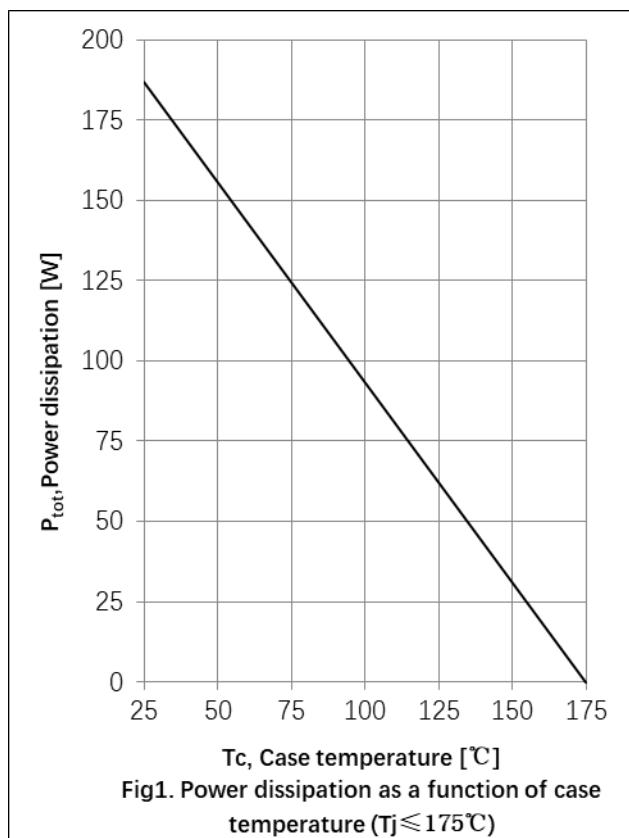
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Dynamic , at T_j= 25°C						
Turn-on Delay Time	t _{d(on)}	V _{CC} =400V, I _C =30A, V _{GE} = 0v~15V, R _g =10Ω,L _s =60nH	-	8	-	ns
Rise Time	t _r		-	22	-	ns
Turn-on Energy	E _{on}		-	1.05	-	mJ
Turn-off Delay Time	t _{d(off)}		-	80	-	ns
Fall Time	t _f		-	84	-	ns
Turn-off Energy	E _{off}		-	0.49	-	mJ
Dynamic , at T_j= 125°C						
Turn-on Delay Time	t _{d(on)}	V _{CC} =400V, I _C =30A, V _{GE} = 0v~15V, R _g =10Ω,L _s =60nH	-	7	-	ns
Rise Time	t _r		-	21	-	ns
Turn-on Energy	E _{on}		-	1.11	-	mJ
Turn-off Delay Time	t _{d(off)}		-	86	-	ns
Fall Time	t _f		-	112	-	ns
Turn-off Energy	E _{off}		-	0.64	-	mJ
Dynamic , at T_j= 150°C						
Turn-on Delay Time	t _{d(on)}	V _{CC} =400V, I _C =30A, V _{GE} = 0v~15V, R _g =10Ω,L _s =60nH	-	8	-	ns
Rise Time	t _r		-	21	-	ns
Turn-on Energy	E _{on}		-	1.14	-	mJ
Turn-off Delay Time	t _{d(off)}		-	90	-	ns
Fall Time	t _f		-	135	-	ns
Turn-off Energy	E _{off}		-	0.73	-	mJ

**Electrical Characteristics of the DIODE**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Dynamic , at T_j= 25°C						
Reverse Recovery Current	I _{rr}	I _F =30A, V _R =400V di/dt= -350A/μs,	-	7	-	A
Reverse Recovery Charge	Q _{rr}		-	0.14	-	uC
Diode reverse recovery time	trr		-	42	-	ns
Reverse Recovery Energy	Erec		-	0.09	-	mJ
Dynamic , at T_j= 125°C						
Reverse Recovery Current	I _{rr}	I _F =30A, V _R =400V di/dt= -350A/μs,	-	13	-	A
Reverse Recovery Charge	Q _{rr}		-	0.94	-	uC
Diode reverse recovery time	trr		-	153	-	ns
Reverse Recovery Energy	Erec		-	0.22	-	mJ
Dynamic , at T_j= 150°C						
Reverse Recovery Current	I _{rr}	I _F =30A, V _R =400V di/dt= -350A/μs,	-	15	-	A
Reverse Recovery Charge	Q _{rr}		-	1.26	-	uC
Diode reverse recovery time	trr		-	161	-	ns
Reverse Recovery Energy	Erec		-	0.26	-	mJ

Thermal Resistance

Parameter	Symbol	Max. Value	Unit
IGBT Thermal Resistance, Junction - Case	R _{th(j-c)}	0.80	K/W
Diode Thermal Resistance, Junction - Case	R _{th(j-c)}	1.4	K/W
Thermal Resistance, Junction - Ambient	R _{th(j-a)}	40	K/W



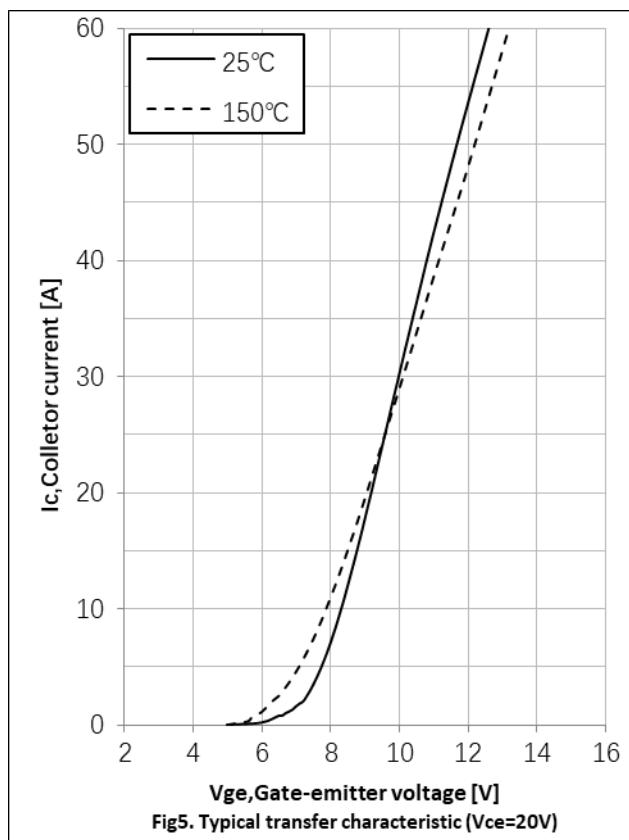


Fig5. Typical transfer characteristic ($V_{ce}=20\text{V}$)

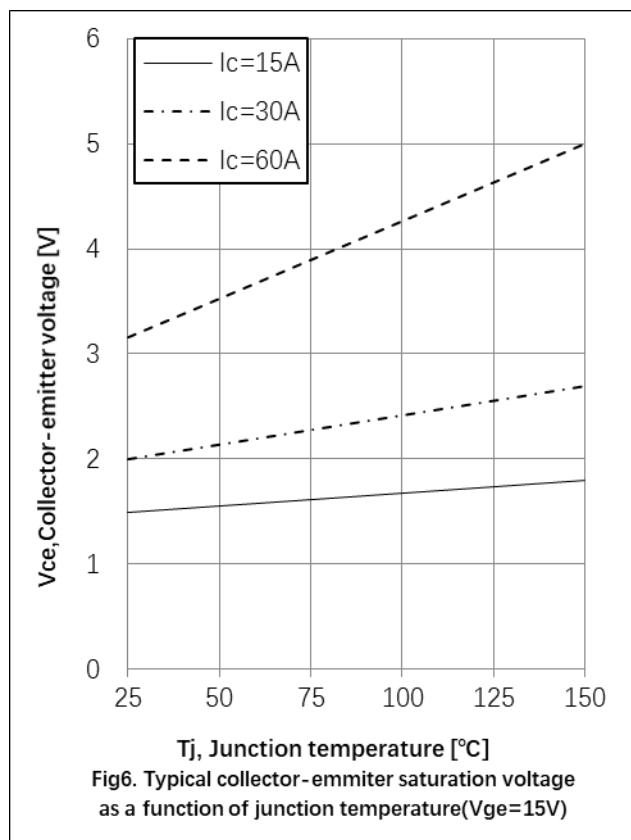


Fig6. Typical collector-emitter saturation voltage as a function of junction temperature($V_{ge}=15\text{V}$)

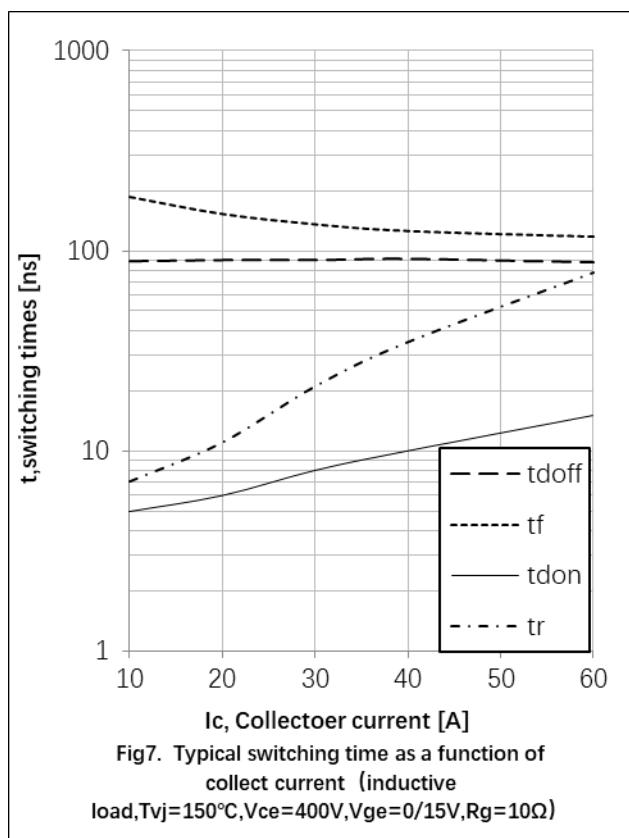


Fig7. Typical switching time as a function of collect current (inductive load, $T_{vj}=150^\circ\text{C}, V_{ce}=400\text{V}, V_{ge}=0/15\text{V}, R_g=10\Omega$)

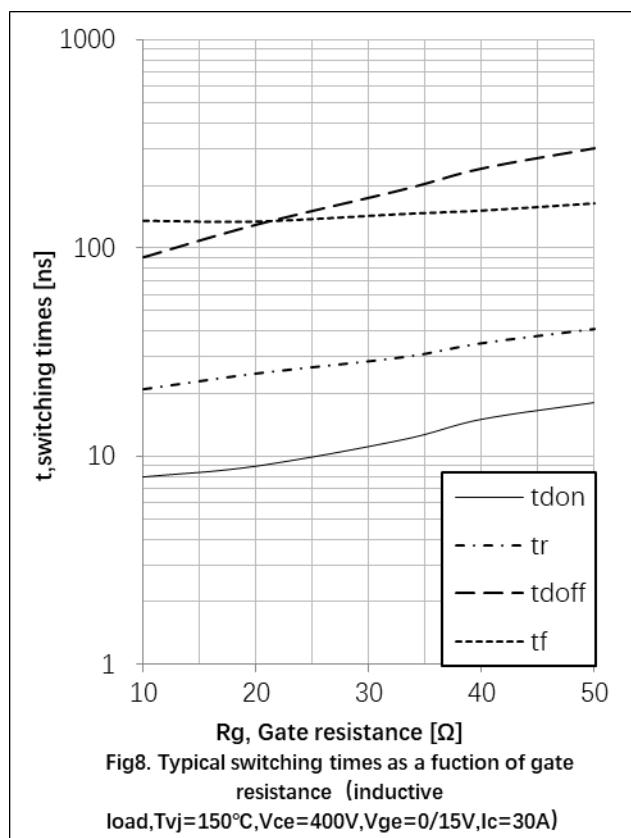
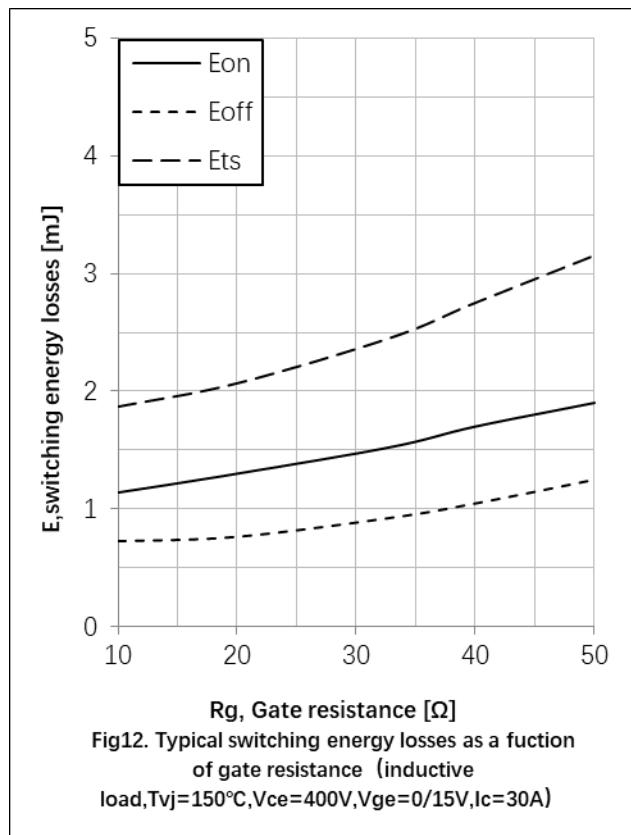
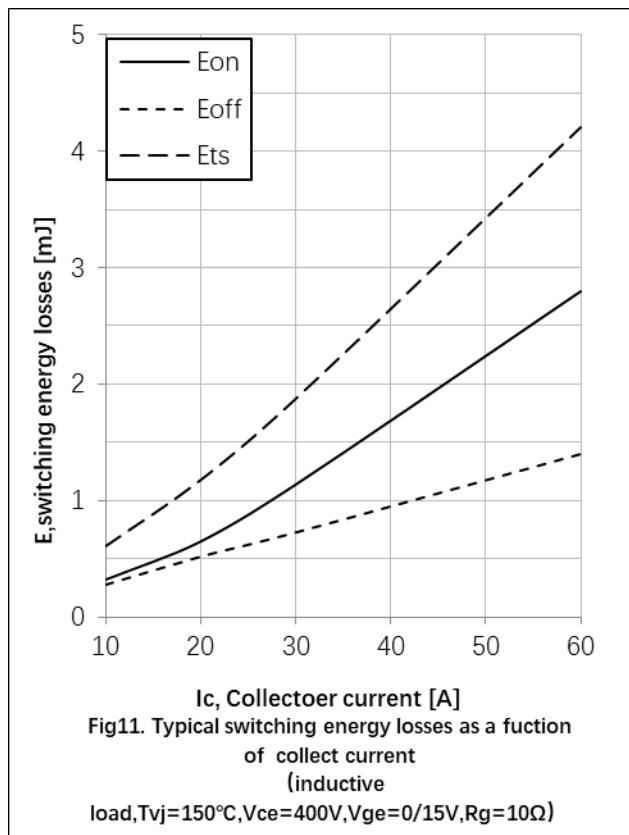
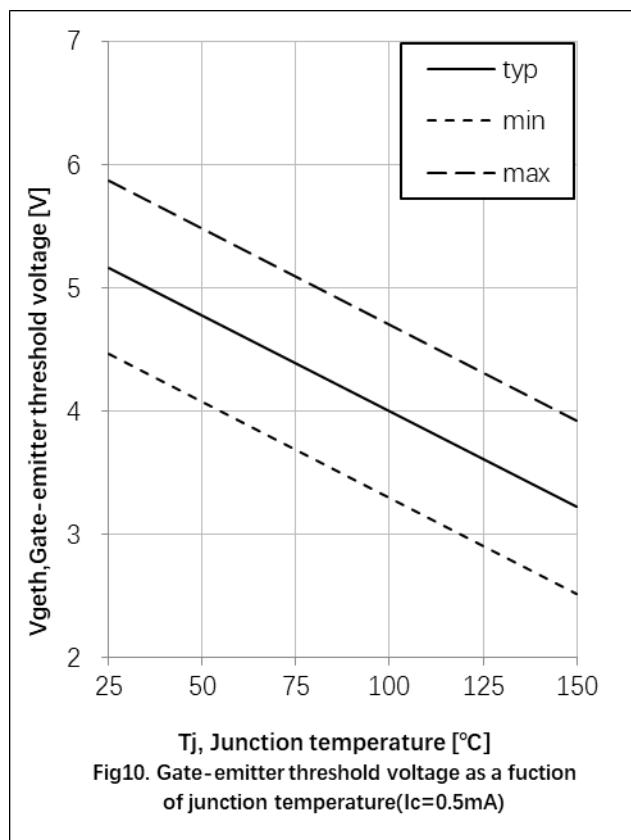
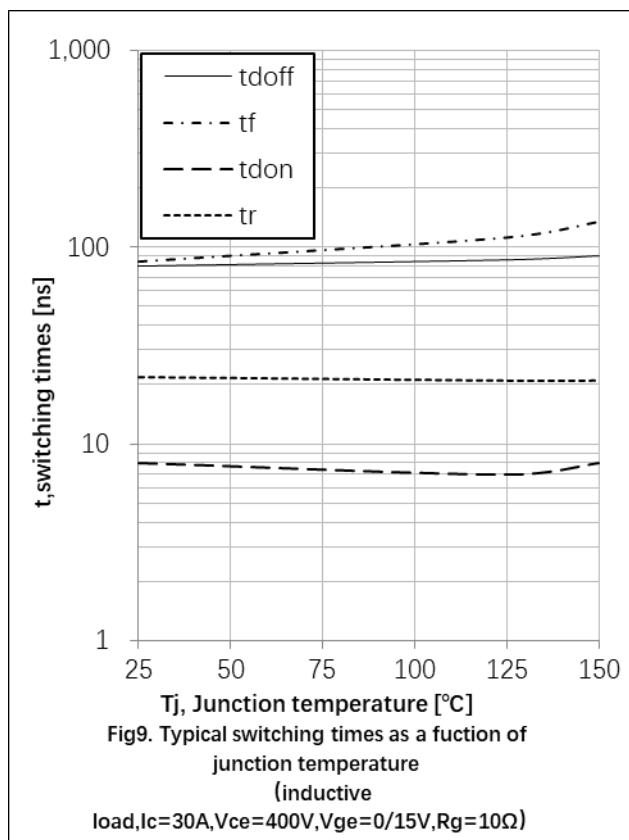
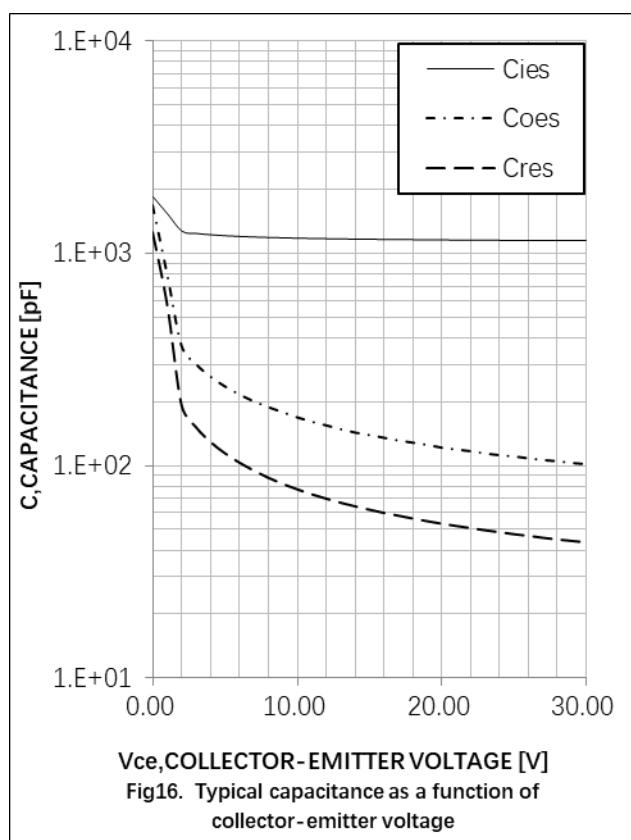
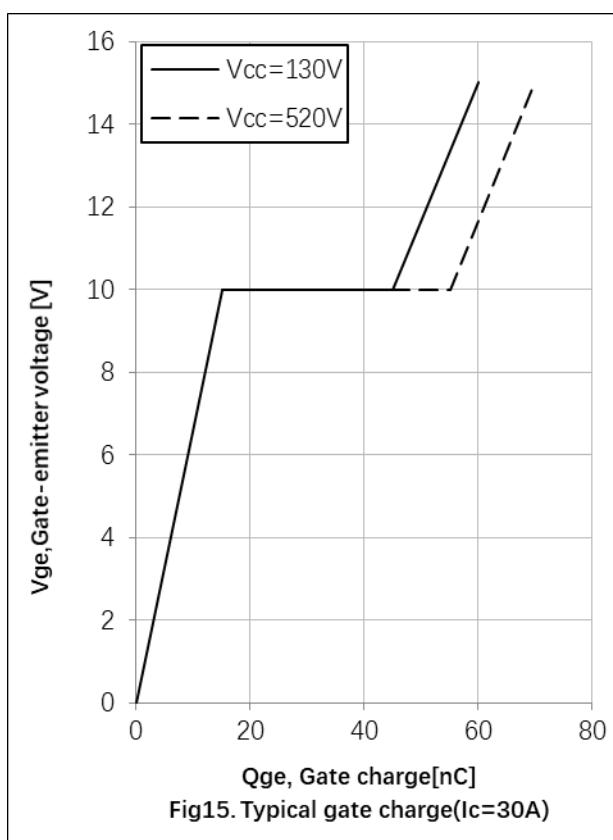
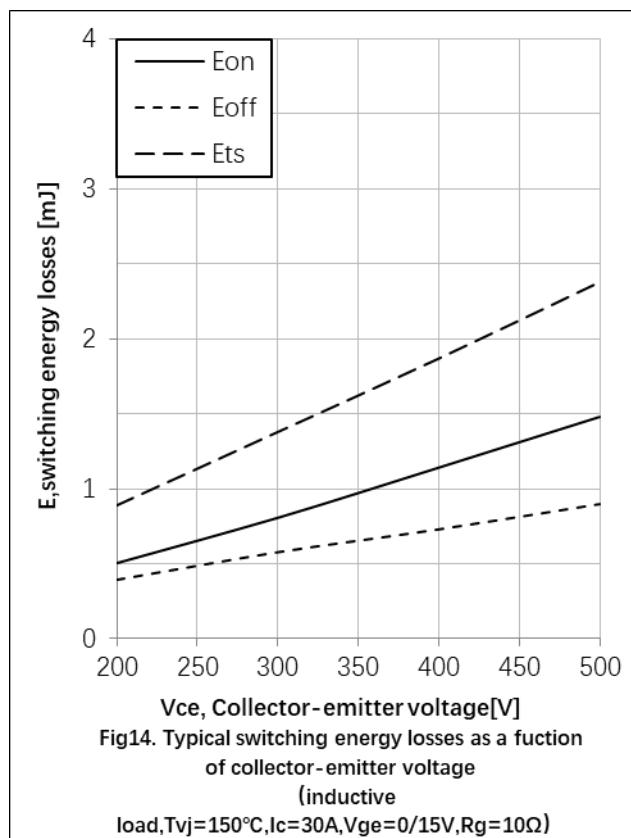
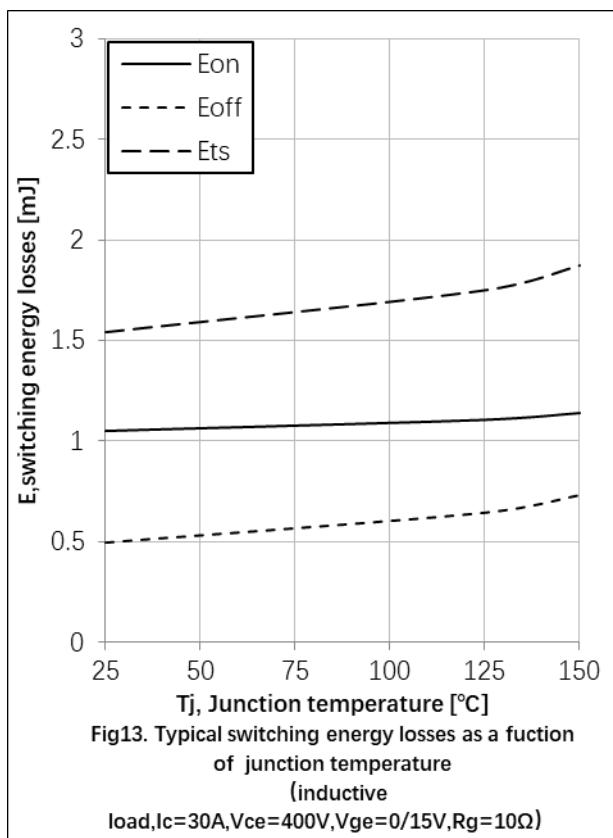
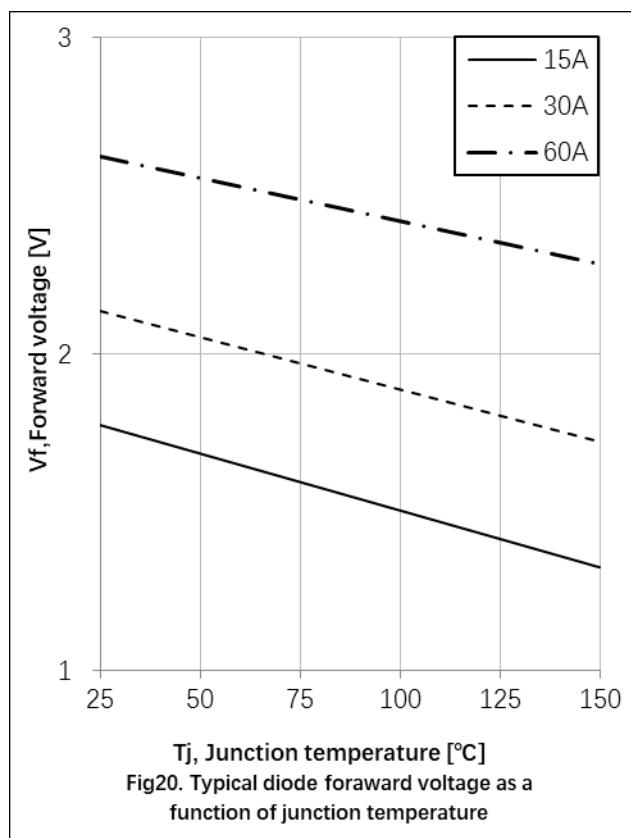
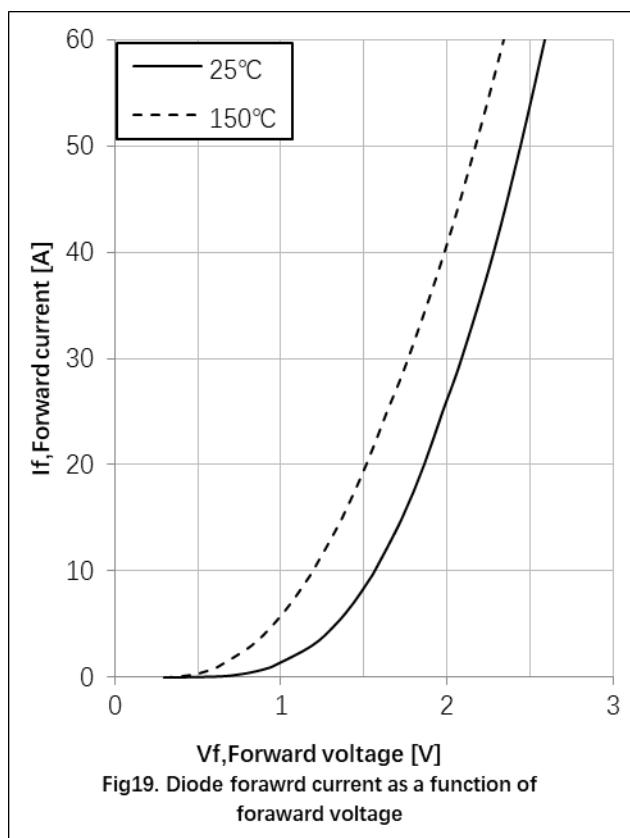
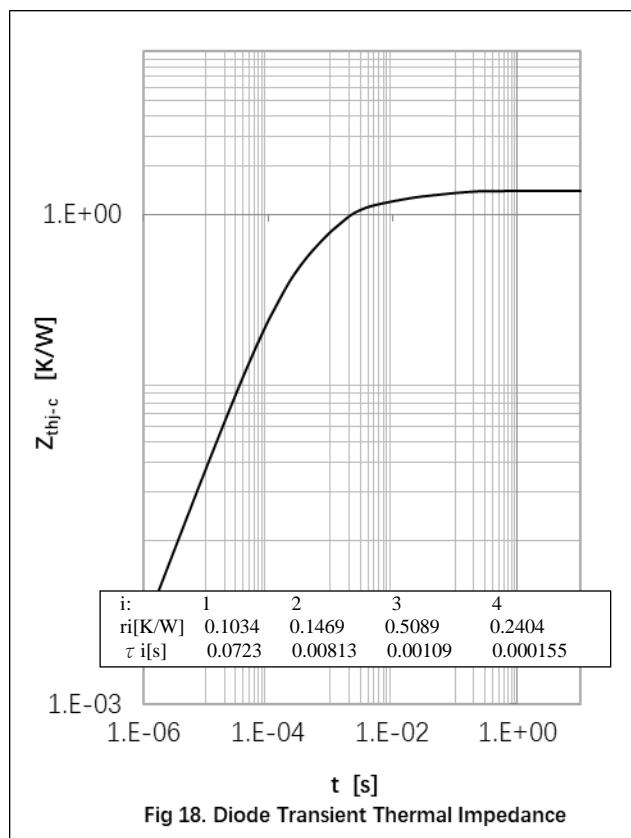
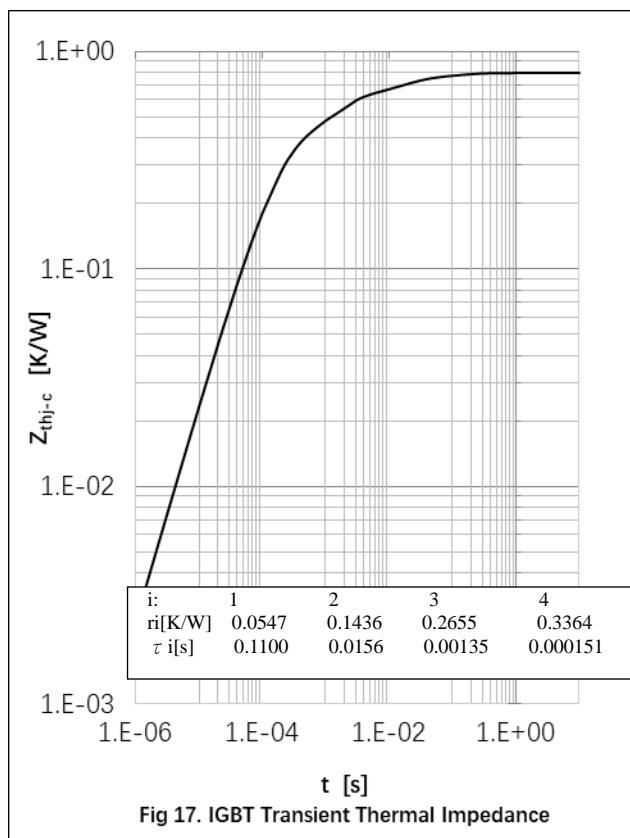


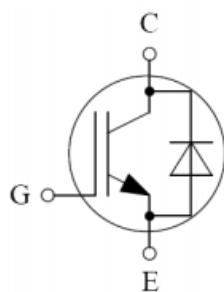
Fig8. Typical switching times as a function of gate resistance (inductive load, $T_{vj}=150^\circ\text{C}, V_{ce}=400\text{V}, V_{ge}=0/15\text{V}, I_c=30\text{A}$)



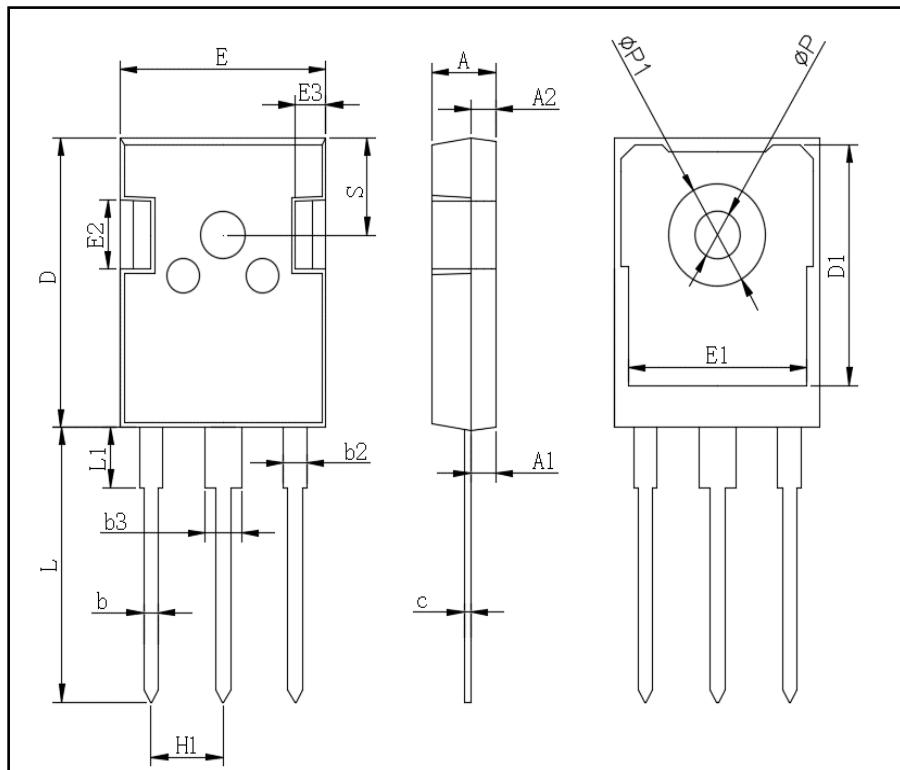




- Circuit Diagram



- Package Outline Information



TO-247AB		
Dim	Min	Max
A	4.80	5.20
A1	2.21	2.61
A2	1.85	2.15
b	1.0	1.4
b2	1.91	2.21
C	0.5	0.7
D	20.70	21.30
D1	16.25	16.85
E	15.50	16.10
E1	13.0	13.6
E2	4.80	5.20
E3	2.30	2.70
L	19.62	20.22
L1	-	4.30
ΦP	3.40	3.80
ΦP1	-	7.30
S	6.15TYP	
H1	5.44TYP	
b3	2.80	3.20